# Dimmable Quasi-Resonant Primary Side Current-Mode Controller for LED Lighting with Thermal Fold-back

The NCL30083 is a PWM current mode controller targeting isolated flyback and non−isolated constant current topologies. The controller operates in a quasi−resonant mode to provide high efficiency. Thanks to a novel control method, the device is able to precisely regulate a constant LED current from the primary side. This removes the need for secondary side feedback circuitry, biasing and an optocoupler.

The device is highly integrated with a minimum number of external components. A robust suite of safety protection is built in to simplify the design. This device is specifically intended for very compact space efficient designs. It supports step dimming by monitoring the AC line and detecting when the line has been toggled on−off−on by the user to reduce the light intensity in 5 steps down to 5% dimming.

#### **Features**

- Quasi−resonant Peak Current−mode Control Operation
- Primary Side Sensing (no optocoupler needed)
- Wide  $V_{CC}$  Range
- Source 300 mA/Sink 500 mA Totem Pole Driver with 12 V Gate Clamp
- Precise LED Constant Current Regulation ±1% Typical
- Line Feed−forward for Enhanced Regulation Accuracy
- Low LED Current Ripple
- 250 mV  $\pm$ 2% Guaranteed Voltage Reference for Current Regulation
- $\bullet \sim 0.9$  Power Factor with Valley Fill Input Stage
- Low Start-up Current (13 µA typ.)
- 5 State Quasi−log Dimmable
- Thermal Fold−back
- Programmable soft−start
- Wide Temperature Range of −40 to +125°C
- Pb−free, Halide−free MSL1 Product
- Robust Protection Features
	- ♦ Over Voltage / LED Open Circuit Protection
	- ♦ Over Temperature Protection
	- ♦ Secondary Diode Short Protection
	- ♦ Output Short Circuit Protection
	- ♦ Shorted Current Sense Pin Fault Detection

#### **Typical Applications**

- Integral LED Bulbs
- LED Power Driver Supplies
- LED Light Engines



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#### **MARKING DIAGRAM**



- AAx = Specific Device Code
- $x = E \text{ or } F$
- $A =$ Assembly Location<br>Y = Year  $=$  Year
- $W = Work Week$

-

- = Pb−Free Package
- (Note: Microdot may be in either location)



L30083x = Specific Device Code

 $x = B$ 

- A = Assembly Location
- $L = Water Lot$
- $Y = Year$ <br> $W = Work$
- $=$  Work Week -
- = Pb−Free Package
- ♦ Latched and Auto−recoverable Versions
- ♦ Brown−out
- V<sub>CC</sub> Under Voltag**PIN CONNECTIONS**
- Thermal Shutdown 1

 $SD$   $\Box$  $\Box$  $\Box$  $\overline{m}$  ss  $ZCD$   $\Box$ E VIN  $\overline{\mathbf{H}}$  vcc  $cs \equiv$  $GND$   $\Box$ bo DRV (Top View)

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page [35](#page-32-0) of this data sheet.



**Figure 1. Typical Application Schematic for NCL30083**







**Figure 2. Internal Circuit Architecture**



#### **Table 2. MAXIMUM RATINGS TABLE**

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. V<sub>DRV</sub> is the DRV clamp voltage V<sub>DRV(high)</sub> when V<sub>CC</sub> is higher than V<sub>DRV(high)</sub>. V<sub>DRV</sub> is V<sub>CC</sub> unless otherwise noted.<br>2. This device series contains ESD protection and exceeds the following tests: Human Body Mo Machine Model Method 200 V per JEDEC JESD22−A115−A.

3. This device contains latch−up protection and exceeds 100 mA per JEDEC Standard JESD78 except for VIN pin which passes 60 mA.

<span id="page-4-0"></span>



[4](#page-6-0). Guaranteed by design

[5](#page-6-0).  $\>$  OTP triggers when R $_{\rm NTC}$  = 4.7 k $\Omega$ 





[4](#page-6-0). Guaranteed by design

[5](#page-6-0). OTP triggers when  $R_{\text{NTC}}$  = 4.7 k $\Omega$ 

<span id="page-6-0"></span>



4. Guaranteed by design

5. OTP triggers when  $R_{\text{NTC}}$  = 4.7 k $\Omega$ 



#### **TYPICAL CHARACTERISTICS**

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### **TYPICAL CHARACTERISTICS**

Figure 19. V<sub>REF40</sub> vs. Junction Temperature Figure 20. V<sub>REF25</sub> vs. Junction Temperature



### **TYPICAL CHARACTERISTICS**

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![](_page_14_Figure_1.jpeg)

#### 0.906 56.0 55.5 0.904 55.0 (au) (MNZ18) CB tBO(BLANK) (ms)  $\geq 0.902$  $\begin{array}{c} \lesssim$  0.902<br>କ୍ରିଁ<br>> 0.900 54.5 54.0 53.5 0.898 53.0  $52.5$   $-40$  $0.896$   $-40$ −40 −20 0 20 40 60 80 100 120 −40 −20 0 20 40 60 80 100 120  $T_J$ , JUNCTION TEMPERATURE (°C)  $T_J$ , JUNCTION TEMPERATURE (°C) Figure 51. V<sub>BO(off)</sub> vs. Junction Temperature Figure 52. t<sub>BO(BLANK)</sub> vs. Junction **Temperature**

### **TYPICAL CHARACTERISTICS**

### **APPLICATION INFORMATION**

The **NCL30083** implements a current−mode architecture operating in quasi−resonant mode. Thanks to proprietary circuitry, the controller is able to accurately regulate the secondary side current of the flyback converter without using any opto−coupler or measuring directly the secondary side current.

- **Quasi−Resonance Current−Mode Operation:** implementing quasi−resonance operation in peak current−mode control, the NCL30083 optimizes the efficiency by switching in the valley of the MOSFET drain−source voltage. Thanks to a smart control algorithm, the controller locks−out in a selected valley and remains locked until the input voltage or the output current set point significantly changes.
- **Primary Side Constant Current Control:** thanks to a proprietary circuit, the controller is able to take into account the effect of the leakage inductance of the transformer and allow accurate control of the secondary side current.
- **Line Feed−forward:** compensation for possible variation of the output current caused by system slew rate variation.
- **Open LED protection:** if the voltage on the VCC pin exceeds an internal limit, the controller shuts down and waits 4 seconds before restarting pulsing.
- **Thermal Fold−back / Over Temperature / Over Voltage Protection:** by combining a dual threshold on the SD pin, the controller allows the direct connection of an NTC to ground plus a Zener diode to a monitored voltage. The temperature is monitored and the output current is linearly reduced in the event that the temperature exceeds a prescribed level. If the

temperature continues to increase, the current will be further reduced until the controller is stopped. The control will automatically restart if the temperature is reduced. This pin can implement a programmable OVP shutdown that can also auto−restart the device.

- **Brown−Out:** the controller includes a brown−out circuit which safely stops the controller in case the input voltage is too low. The device will automatically restart if the line recovers.
- **Cycle−by−cycle peak current limit:** when the current sense voltage exceeds the internal threshold V<sub>ILIM</sub>, the MOSFET is turned off for the rest of the switching cycle.
- **Winding Short−Circuit Protection:** an additional comparator with a short LEB filter  $(t_{BCS})$  senses the CS signal and stops the controller if  $V_{CS}$  reaches 1.5 x VILIM. For noise immunity reasons, this comparator is enabled only during the main LEB duration t<sub>LEB</sub>.
- **Output Short−circuit protection:** If a very low voltage is applied on ZCD pin for 90 ms (nominal), the controllers assume that the output or the ZCD pin is shorted to ground and enters shutdown. The auto−restart version (B suffix) waits 4 seconds, then the controller restarts switching. In the latched version (A suffix), the controller is latched as long as  $V_{CC}$  stays above the  $V_{CC(reset)}$  threshold.
- **Soft−start:** The soft−start pin can be used to slowly increase the output current at startup and provide a smooth turn−on of the LED light.
- **Step dimming:** Each time the IC detects a brown−out condition, the output current is decreased by discrete steps.

#### **Constant Current Control**

Figure [54](#page-17-0) portrays the primary and secondary current of a flyback converter in discontinuous conduction mode (DCM). Figure 53 shows the basic circuit of a flyback converter.

![](_page_16_Figure_3.jpeg)

**Figure 53. Basic Flyback Converter Schematic**

During the on−time of the MOSFET, the bulk voltage  $V_{\text{bulk}}$  is applied to the magnetizing and leakage inductors  $L_{\text{p}}$ and  $L_{\text{leak}}$  and the current ramps up.

When the MOSFET is turned−off, the inductor current first charges  $C_{\text{lump}}$ . The output diode is off until the voltage across Lp reverses and reaches:

$$
N_{sp}(V_{out} + V_f)
$$
 (eq. 1)

The output diode current increase is limited by the leakage inductor. As a consequence, the secondary peak current is reduced:

$$
I_{D,pk} < \frac{I_{L,pk}}{N_{sp}} \tag{eq.2}
$$

The diode current reaches its peak when the leakage inductor is reset. Thus, in order to accurately regulate the output current, we need to take into account the leakage inductor current. This is accomplished by sensing the clamping network current. Practically, a node of the clamp capacitor is connected to  $R_{\text{sense}}$  instead of the bulk voltage  $V_{\text{bulk}}$ . Then, by reading the voltage on the CS pin, we have an image of the primary current (red curve in Figure [54](#page-17-0)).

When the diode conducts, the secondary current decreases linearly from  $I_{D, p k}$  to zero. When the diode current has turned off, the drain voltage begins to oscillate because of the resonating network formed by the inductors  $(L_p+L_{leak})$ and the lump capacitor. This voltage is reflected on the auxiliary winding wired in flyback mode. Thus, by looking at the auxiliary winding voltage, we can detect the end of the conduction time of secondary diode. The constant current control block picks up the leakage inductor current, the end of conduction of the output rectifier and controls the drain current to maintain the output current constant.

We have:

$$
I_{\text{out}} = \frac{V_{\text{REF}}}{2N_{\text{sp}}R_{\text{sense}}}
$$
 (eq. 3)

The output current value is set by choosing the sense resistor:

$$
R_{\text{sense}} = \frac{V_{\text{ref}}}{2N_{\text{spl}}}
$$
 (eq. 4)

From Equation 3, the first key point is that the output current is independent of the inductor value. Moreover, the leakage inductance does not influence the output current value as the reset time is taken into account by the controller.

<span id="page-17-0"></span>![](_page_17_Figure_1.jpeg)

**Figure 54. Flyback Currents and Auxiliary Winding Voltage in DCM**

#### **Internal Soft−Start**

At startup or after recovering from a fault, there is a small internal soft–start of 40  $\mu$ s.

In addition, during startup, as the output voltage is zero volts, the demagnetization time is long and the constant

current control block will slowly increase the peak current towards its nominal value as the output voltage grows. Figure [55](#page-18-0) shows a soft−start simulation example for a 9 W LED power supply.

<span id="page-18-0"></span>![](_page_18_Figure_1.jpeg)

**Figure 55. Startup Simulation Showing the Natural Soft−start**

#### **Cycle−by−Cycle Current Limit**

When the current sense voltage exceeds the internal threshold V<sub>ILIM</sub>, the MOSFET is turned off for the rest of the switching cycle (Figure [56](#page-19-0)).

#### **Winding and Output Diode Short−Circuit Protection**

In parallel with the cycle−by−cycle sensing of the CS pin, another comparator with a reduced LEB ( $t_{BCS}$ ) and a higher threshold (1.5 V typical) is able to sense winding short−circuit and immediately stops the DRV pulses. The controller goes into auto−recovery mode in version B.

In version A, the controller is latched. In latch mode, the DRV pulses stop and VCC ramps up and down. The circuit un–latches when VCC pin voltage drops below  $V_{CC(reset)}$ threshold.

<span id="page-19-0"></span>![](_page_19_Figure_1.jpeg)

**Figure 56. Winding Short Circuit Protection, Max. Peak Current Limit Circuits**

#### **Thermal Fold−back and Over Voltage / Over Temperature Protection**

The thermal fold−back circuit reduces the current in the LED string when the ambient temperature exceeds a set point. The current is gradually reduced to 50% of its nominal value if the temperature continues to rise. (Figure [58](#page-20-0)). The thermal foldback starting temperature depends on the Negative Coefficient Temperature (NTC) resistor chosen by the power supply designer.

Indeed, the SD pin allows the direct connection of an NTC to sense the ambient temperature. When the SD pin voltage  $V_{SD}$  drops below  $V_{TF(stat)}$ , the internal reference for the constant current control V<sub>REF</sub> is decreased proportionally to  $V_{SD}$ . When  $V_{SD}$  reaches  $V_{TF(stop)}$ ,  $V_{REF}$  is clamped to VREF50, corresponding to 50% of the nominal output current.

If  $V_{SD}$  drops below  $V_{OTP}$ , the controller enters into the auto−recovery fault mode for version B, meaning that the 4−s timer is activated. The controller will re−start switching after the 4-s timer has elapsed and when  $V_{SD} > V_{OTP(0n)}$  to provide some temperature hysteresis (around 10°C).

For version A, this protection is latched: reset occurs when  $V_{CC}$  <  $V_{CC(reset)}$ .

The thermal fold−back and OTP thresholds correspond roughly to the following resistances:

- Thermal fold–back starts when  $R_{NTC} \le 11.76$  k $\Omega$ .
- Thermal fold–back stops when  $R_{NTC} \leq 8.24$  k $\Omega$ .
- OTP triggers when  $R_{NTC} \le 5.88$  k $\Omega$ .
- OTP is removed when  $R_{NTC} \geq 8.24$  k $\Omega$ .

![](_page_19_Figure_13.jpeg)

**Figure 57. Output Current Reduction versus SD Pin Voltage**

<span id="page-20-0"></span>At startup, when  $V_{CC}$  reaches  $V_{CC(on)}$ , the controller is not allowed to start pulsing for at least 180 µs in order to allow the SD pin voltage to reach its nominal value if a filtering capacitor is connected to the SD pin. This is to avoid flickering of the LED light in case of over temperature.

![](_page_20_Figure_3.jpeg)

**Figure 58. Thermal Fold−back and OVP/OTP Circuitry**

In case of over voltage, the Zener diode starts to conduct and inject current inside the internal clamp resistor R<sub>clamp</sub> thus causing the pin SD voltage to increase. When this

voltage reaches the OVP threshold (2.5 V typ.), the controller shuts−down and waits for at least 4 seconds before restarting switching.

![](_page_21_Figure_1.jpeg)

**Figure 59. OVP with SD Pin Chronograms**

![](_page_22_Figure_1.jpeg)

**Figure 60. Thermal Fold−back / OTP Chronograms**

#### **Soft−Start**

The NCL30083 provides a soft−start pin allowing increasing slowly the LEDs light at startup. An internal current source ISST charges the soft−start capacitor. The generated voltage ramp directly controls the amount of current flowing in the LEDs.

At startup, if there are no faults (except "Enable\_b" high), an internal pre−charging current source ISST(pre) connected in parallel with ISST charges the soft−start capacitor until it reaches the  $V_{SST(EN)}$  threshold. After that,  $I_{SST(pre)}$  is turned off and the soft−start capacitor keep on charging with the soft−start current source ISST.

When a fault is detected, the soft−start pin is discharged down to V<sub>SST(EN)</sub> to provide a clean soft–start when the fault is removed.

![](_page_22_Figure_8.jpeg)

**Figure 61. Soft−start Pin Bloc Diagram**

#### **Step Dimming**

The step dimming function decreases the output current from 100% to 5% of its nominal value in discrete steps. There are 5 steps in total. Table 4 shows the different steps value and the corresponding output current set−point. Each time a brown−out is detected, the output current is decreased by decreasing the reference voltage  $V_{REF}$  setting the output current value.

When the 5% dimming step is reached, if a brown−out event occurs, the controller restarts at 100% of the output current.

#### **Table 4. DIMMING STEPS**

![](_page_23_Picture_228.jpeg)

#### Note:

The power supply designer must ensure that  $V_{CC}$  stays high enough when the light is turned−off to let the controller memorize the dimming step state.

The power supply designer should use a split  $V_{CC}$  circuit for step dimming with a capacitor allowing providing enough  $V_{CC}$  for 1 s (47  $\mu$ F to 100  $\mu$ F capacitor).

The step dimming state is memorized by the controller until  $V_{CC}$  crosses  $V_{CC(reset)}$ .

![](_page_23_Figure_10.jpeg)

**Figure 62. Split VCC Supply**

![](_page_23_Figure_12.jpeg)

**Figure 63. Step Dimming Chronograms**

#### **V<sub>CC</sub> Over Voltage Protection (Open LED Protection)**

If no output load is connected to the LED power supply, the controller must be able to safely limit the output voltage excursion.

In the NCL30083, when the  $V_{CC}$  voltage reaches the  $V_{\text{CC(OVP)}}$  threshold, the controller stops the DRV pulses and the 4−s timer starts counting. The IC re−start pulsing after the 4–s timer has elapsed and when  $V_{CC} \geq V_{CC(on)}$ .

![](_page_24_Figure_4.jpeg)

**Figure 64. Open LED Protection Chronograms**

#### **Valley Lockout**

Quasi−Square wave resonant systems have a wide switching frequency excursion. The switching frequency increases when the output load decreases or when the input voltage increases. The switching frequency of such systems must be limited.

The NCL30083 changes valley as the input voltage increases and as the output current set−point is varied (thermal fold−back and step dimming). This limits the switching frequency excursion. Once a valley is selected, the controller stays locked in the valley until the input

voltage or the output current set−point varies significantly. This avoids valley jumping and the inherent noise caused by this phenomenon.

The input voltage is sensed by the VIN pin. The internal logic selects the operating valley according to VIN pin voltage (line range detector in Figure [65](#page-25-0)), SD pin voltage and dimming state imposed by the Step Dimming circuit.

By default, when the output current is not dimmed, the controller operates in the first valley at low line and in the second valley at high line.

<span id="page-25-0"></span>![](_page_25_Figure_1.jpeg)

### **Figure 65. Line Range Detector**

### **Table 5. VALLEY SELECTION**

![](_page_25_Picture_168.jpeg)

#### **Zero Crossing Detection Block**

The ZCD pin allows detecting when the drain−source voltage of the power MOSFET reaches a valley.

A valley is detected when the voltage on pin 1 crosses below the  $V_{ZCD(THD)}$  internal threshold.

At startup or in case of extremely damped free oscillations, the ZCD comparator may not be able to detect the valleys. To avoid such a situation, the NCL30083 features a Time−Out circuit that generates pulses if the voltage on ZCD pin stays below the  $V_{ZCD(THD)}$  threshold for  $6.5 \mu s$ .

The Time−out also acts as a substitute clock for the valley detection and simulates a missing valley in case of too damped free oscillations.

![](_page_26_Figure_7.jpeg)

**Figure 66. Time−out Chronograms**

Because of this time−out function, if the ZCD pin or the auxiliary winding is shorted, the controller will continue switching leading to improper regulation of the LED current. Moreover during an output short circuit, the controller will strive to maintain the constant current operation.

In order to avoid these scenarios, a secondary timer starts counting when the ZCD voltage is below the  $V_{ZCD(short)}$ threshold. If this timer reaches 90 ms, the controller detects a fault and enters the auto−recovery fault mode (controller shuts−down and waits 4−s before re−starting switching).

#### **Line Feed−forward**

Because of the propagation delays, the MOSFET is not turned−off immediately when the current set−point is reached. As a result, the primary peak current is higher than expected and the output current increases. To compensate the peak current increase brought by the propagation delay, a positive voltage proportional to the line voltage is added on the current sense signal. The amount of offset voltage can be adjusted using the  $R_{\text{LFF}}$  resistor as shown in Figure [67](#page-27-0).

The offset voltage is applied only during the MOSFET on−time.

This offset voltage is removed at light load during dimming when the output current drops below 15% of the programmed output current.

<span id="page-27-0"></span>![](_page_27_Figure_1.jpeg)

**Figure 67. Line Feed−Forward Schematic**

#### **Brown−out**

In order to protect the supply against a very low input voltage, the NCL30083 features a brown−out circuit with a fixed ON/OFF threshold. The controller is allowed to start if a voltage higher than 1 V is applied to the VIN pin and

shuts−down if the VIN pin voltage decreases and stays below 0.9 V for 50 ms nominal. Exiting a brown−out condition overrides the hiccup on  $V_{CC}$  (V<sub>CC</sub> does not wait to reach  $V_{CC(off)}$ ) and the IC immediately goes into startup mode  $(I_{CC} = I_{CC(stat)})$ .

![](_page_27_Figure_6.jpeg)

![](_page_28_Figure_1.jpeg)

**Figure 69. Brown−Out Chronograms (Valley Fill circuit is used)**

#### **CS Pin Short Circuit Protection**

Normally, if the CS pin or the sense resistor is shorted to ground, the Driver will not be able to turn off, leading to potential damage of the power supply. To avoid this, the NCL30083 features a circuit to protect the power supply against a short circuit of the CS pin. When the MOSFET is on, if the CS voltage stays below  $V_{CS(low)}$  after the adaptive blanking timer has elapsed, the controller shuts down and will attempt to restart on the next  $V_{CC}$  hiccup.

![](_page_29_Figure_4.jpeg)

**Figure 70. CS Pin Short Circuit Protection Schematic**

#### **Fault Management**

#### OFF Mode

The circuit turns off whenever a major condition prevents it from operating:

- Incorrect feeding of the circuit: "UVLO high". The UVLO signal becomes high when  $V_{CC}$  drops below  $V_{CC(off)}$  and remains high until  $V_{CC}$  exceeds  $V_{CC(on)}$ .
- OTP
- $\bullet$  V<sub>CC</sub> OVP
- OVP2 (additional OVP provided by SD pin)
- Output diode short circuit protection: "WOD\_SCP high"
- Output / Auxiliary winding Short circuit protection: "Aux\_SCP high"
- Die over temperature (TSD)
- Brown−Out: "BO\_NOK" high
- Pin CS short circuited to GND: "CS\_short high"

In this mode, the DRV pulses are stopped. The VCC voltage decrease through the controller own consumption  $(I_{CC1})$ .

For the output diode short circuit protection, the CS pin short circuit protection, the output / aux. winding short circuit protection and the OVP2, the controller waits 4 seconds (auto−recovery timer) and then initiates a startup sequence ( $V_{CC}$  ≥  $V_{CC(on)}$ ) before re−starting switching.

#### Latch Mode

This mode is activated by the output diode short−circuit protection (WOD\_SCP), the OTP and the Aux−SCP in **version A only.**

In this mode, the DRV pulses are stopped and the controller is latched. There are hiccups on  $V_{CC}$ .

The circuit un–latches when  $V_{CC}$  < V<sub>CC(reset)</sub>.

![](_page_30_Figure_1.jpeg)

**Figure 71. State Diagram for B Version Faults**

![](_page_31_Figure_1.jpeg)

**Figure 72. State Diagram for A Version Faults**

#### <span id="page-32-0"></span>**OPTIONS**

![](_page_32_Picture_104.jpeg)

#### **ORDERING INFORMATION**

![](_page_32_Picture_105.jpeg)

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

![](_page_33_Picture_2.jpeg)

![](_page_33_Figure_3.jpeg)

\*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **STYLES ON PAGE 2**

![](_page_33_Picture_512.jpeg)

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#### **SOIC−8 NB** CASE 751−07 ISSUE AK

STYLE 1: PIN 1. EMITTER 2. COLLECTOR<br>3. COLLECTOR 3. COLLECTOR<br>4. EMITTER 4. EMITTER<br>5. EMITTER 5. EMITTER<br>6. BASE 6. BASE<br>7 BASE 7. BASE 8. EMITTER STYLE 5: PIN 1. DRAIN 2. DRAIN<br>3. DRAIN **DRAIN** 4. DRAIN<br>5. GATE 5. GATE 6. GATE 7. SOURCE 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON<br>2. COLLECTOR. DIE #1 2. COLLECTOR, DIE #1 3. COLLECTOR, DIE #2<br>4. EMITTER. COMMON 4. EMITTER, COMMON<br>5. EMITTER, COMMON 5. EMITTER, COMMON<br>6. BASE. DIE #2 6. BASE, DIE #2 7. BASE, DIE #1 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3. SOURCE 4. GATE<br>5. DRAIN 5. DRAIN 6. DRAIN<br>7. DRAIN 7. DRAIN<br>8. DRAIN **DRAIN** STYLE 17: PIN 1. VCC 2. V2OUT 3. V1OUT 4. TXE 5. RXE 6. VEE 7. GND ACC STYLE 21: PIN 1. CATHODE 1<br>2. CATHODE 2 2. CATHODE 2<br>3 CATHODE 3 CATHODE 3 4. CATHODE 4 5. CATHODE 5 6. COMMON ANODE<br>7. COMMON ANODE 7. COMMON ANODE CATHODE 6 STYLE 25: PIN 1. VIN 2. N/C<br>3. REX 3. REXT<br>4. GND 4. GND<br>5. IOUT 5. IOUT 6. **IOUT**<br>7. **IOUT** 7. IOUT 8. IOUT STYLE 29: PIN 1. BASE, DIE #1 2. EMITTER, #1 3. BASE, #2 4. EMITTER, #2

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1<br>3. COLLECTOR, #2 3. COLLECTOR, #2 4. COLLECTOR, #2 5. BASE, #2 6. EMITTER,  $#2$ <br>7 BASE  $#1$ **BASE** #1 8. EMITTER, #1 STYLE 6: PIN 1. SOURCE<br>2. DRAIN 2. DRAIN<br>3. DRAIN **DRAIN** 4. SOURCE<br>5. SOURCE 5. SOURCE<br>6. GATE<br>7. GATE **GATE** GATE 8. SOURCE STYLE 10: PIN 1. GROUND<br>2. BIAS 1 BIAS 1 3. OUTPUT<br>4. GROUND 4. GROUND<br>5. GROUND **GROUND** 6. BIAS 2<br>7. INPUT 7. INPUT<br>8. GROU GROUND STYLE 14: PIN 1. N−SOURCE<br>2. N−GATE 2. N−GATE 3. P−SOURCE 4. P−GATE<br>5. P−DRAIN 5. P−DRAIN 6. P−DRAIN 7. N−DRAIN<br>8. N−DRAIN 8. N−DRAIN STYLE 18: PIN 1. ANODE<br>2. ANODE 2. ANODE 3. SOURCE<br>4. GATE 4. GATE<br>5. DRAIN 5. DRAIN<br>6 DRAIN **DRAIN** 7. CATHODE **CATHODE** STYLE 22: PIN 1. I/O LINE 1<br>2. COMMON 2. COMMON CATHODE/VCC<br>3. COMMON CATHODE/VCC COMMON CATHODE/VCC 4. I/O LINE 3 5. COMMON ANODE/GND 6. I/O LINE 4<br>7. I/O LINE 5 7. I/O LINE 5 COMMON ANODE/GND STYLE 26: PIN 1. GND 2. dv/dt 3. ENABLE<br>4. ILIMIT 4. ILIMIT<br>5. SOUR 5. SOURCE<br>6. SOURCE 6. SOURCE<br>7. SOURCE **SOURCE** 8. VCC STYLE 30: PIN 1. DRAIN 1 2. DRAIN 1 3. GATE 2 4. SOURCE 2 5. SOURCE 1/DRAIN 2 6. SOURCE 1/DRAIN 2<br>7. SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2

8. GATE 1

![](_page_34_Picture_987.jpeg)

#### DATE 16 FEB 2011

STYLE 4: PIN 1. ANODE 2. ANODE<br>3. ANODE 3. ANODE 4. ANODE 5. ANODE 6. ANODE 7. ANODE 8. COMMON CATHODE STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 3. BASE, #2 4. COLLECTOR, #2 5. COLLECTOR, #2<br>6. EMITTER, #2<br>7. EMITTER, #1 6. EMITTER, #2 7. EMITTER, #1<br>8. COLLECTOR COLLECTOR, #1 STYLE 12: PIN 1. SOURCE<br>2. SOURCE **SOURCE** 3. SOURCE 4. GATE<br>5. DRAIN 5. DRAIN<br>6. DRAIN<br>7. DRAIN **DRAIN** 7. DRAIN<br>8. DRAIN DRAIN STYLE 16: PIN 1. EMITTER, DIE #1<br>2. BASE, DIE #1 2. BASE, DIE #1 3. EMITTER, DIE #2 4. BASE, DIE #2<br>5. COLLECTOR, 5. COLLECTOR, DIE #2<br>6. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 7. COLLECTOR, DIE #1 8. COLLECTOR, DIE #1 STYLE 20: PIN 1. SOURCE (N) 2. GATE (N) 3. SOURCE (P)<br>4. GATE (P) 4. GATE (P)<br>5. DRAIN 5. DRAIN<br>6 DRAIN **DRAIN** 7. DRAIN<br>8. DRAIN **DRAIN** STYLE 24: PIN 1. BASE<br>2. EMITT 2. EMITTER<br>3 COLLECT COLLECTOR/ANODE 4. COLLECTOR/ANODE<br>5. CATHODE 5. CATHODE 6. CATHODE<br>7. COLLECT 7. COLLECTOR/ANODE<br>8. COLLECTOR/ANODE COLLECTOR/ANODE STYLE 28: PIN 1. SW\_TO\_GND 2. DASIC\_OFF 3. DASIC\_SW\_DET 4. GND 5. V\_MON<br>6. VBULK 6. VBULK<br>7. VBULK 7. VBULK 8. VIN

![](_page_34_Picture_988.jpeg)

rights of others.

5. COLLECTOR, #2 6. COLLECTOR, #2 7. COLLECTOR, #1 COLLECTOR, #1

![](_page_35_Picture_2.jpeg)

![](_page_35_Figure_3.jpeg)

![](_page_35_Picture_291.jpeg)

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